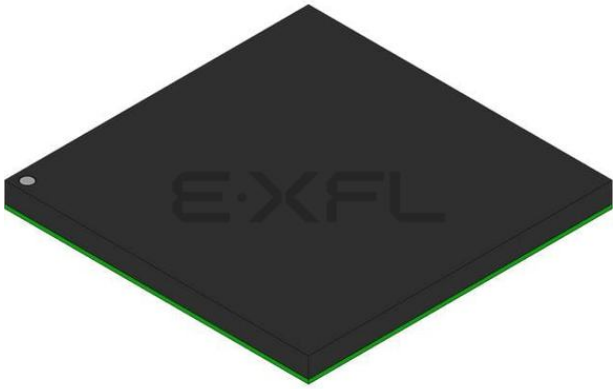

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Understanding Embedded - Microprocessors

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

Applications of Embedded - Microprocessors

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details	
Product Status	Active
Core Processor	PowerPC G2_LE
Number of Cores/Bus Width	1 Core, 32-Bit
Speed	400MHz
Co-Processors/DSP	Communications; RISC CPM, Security; SEC
RAM Controllers	DRAM, SDRAM
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	10/100Mbps (2)
SATA	-
USB	USB 2.0 (1)
Voltage - I/O	3.3V
Operating Temperature	0°C ~ 105°C (TA)
Security Features	Cryptography, Random Number Generator
Package / Case	516-BBGA
Supplier Device Package	516-PBGA (27x27)
Purchase URL	https://www.e-xfl.com/pro/item?MUrl=&PartUrl=mpc8248vrtmfa

1 Overview

This table shows the functionality supported by each SoC in the MPC8272 family.

Table 1. MPC8272 PowerQUICC II Family Functionality

Functionality	SoCs			
	MPC8272	MPC8248	MPC8271	MPC8247
Package[1]	516 PBGA			
Serial communications controllers (SCCs)	3	3	3	3
QUICC multi-channel controller (QMC)	Yes	Yes	Yes	Yes
Fast communication controllers (FCCs)	2	2	2	2
I-Cache (Kbyte)	16	16	16	16
D-Cache (Kbyte)	16	16	16	16
Ethernet (10/100)	2	2	2	2
UTOPIA II Ports	1	0	1	0
Multi-channel controllers (MCCs)	0	0	0	0
PCI bridge	Yes	Yes	Yes	Yes
Transmission convergence (TC) layer	—	—	—	—
Inverse multiplexing for ATM (IMA)	—	—	—	—
Universal serial bus (USB) 2.0 full/low rate	1	1	1	1
Security engine (SEC)	Yes	Yes	—	—

[1] See Table 2.

Devices in the MPC8272 family are available in two packages—the VR or ZQ package—as shown in . For package ordering information, see Section 10, “Ordering Information.”

Table 2. MPC8272 PowerQUICC II Device Packages

Code (Package)	VR (516 PBGA—Lead free)	ZQ (516 PBGA—Lead spheres)
Device	MPC8272VR	MPC8272ZQ
	MPC8248VR	MPC8248ZQ
	MPC8271VR	MPC8271ZQ
	MPC8247VR	MPC8247ZQ

  - Floating-point unit (FPU) supports floating-point arithmetic
  - Support for cache locking
- Low-power consumption
- Separate power supply for internal logic (1.5 V) and for I/O (3.3 V)
- Separate PLLs for G2_LE core and for the communications processor module (CPM)
  - G2_LE core and CPM can run at different frequencies for power/performance optimization
  - Internal core/bus clock multiplier that provides ratios 2:1, 2.5:1, 3:1, 3.5:1, 4:1, 4.5:1, 5:1, 5.5:1, 6:1, 7:1, 8:1
  - Internal CPM/bus clock multiplier that provides ratios 2:1, 2.5:1, 3:1, 3.5:1, 4:1, 5:1, 6:1, 8:1 ratios
- 64-bit data and 32-bit address 60x bus
  - Bus supports multiple master designs—up to two external masters
  - Supports single transfers and burst transfers
  - 64-, 32-, 16-, and 8-bit port sizes controlled by on-chip memory controller
- 60x-to-PCI bridge
  - Programmable host bridge and agent
  - 32-bit data bus, 66 MHz, 3.3 V
  - Synchronous and asynchronous 60x and PCI clock modes
  - All internal address space available to external PCI host
  - DMA for memory block transfers
    - PCI-to-60x address remapping
- System interface unit (SIU)
  - Clock synthesizer
  - Reset controller
  - Real-time clock (RTC) register
  - Periodic interrupt timer
  - Hardware bus monitor and software watchdog timer
  - IEEE 1149.1 JTAG test access port
- Eight bank memory controller
  - Glueless interface to SRAM, page mode SDRAM, DRAM, EPROM, Flash, and other user-definable peripherals
  - Byte write enables
  - 32-bit address decodes with programmable bank size
  - Three user-programmable machines, general-purpose chip-select machine, and page mode pipeline SDRAM machine
  - Byte selects for 64-bit bus width (60x)
  - Dedicated interface logic for SDRAM
- Disable CPU mode

- PCI bridge
  - PCI Specification revision 2.2-compliant and supports frequencies up to 66 MHz
  - On-chip arbitration
  - Support for PCI to 60x memory and 60x memory to PCI streaming
  - PCI host bridge or peripheral capabilities
  - Includes four DMA channels for the following transfers:
    - PCI-to-60x to 60x-to-PCI
    - 60x-to-PCI to PCI-to-60x
    - PCI-to-60x to PCI-to-60x
    - 60x-to-PCI to 60x-to-PCI
  - Includes the configuration registers required by the PCI standard (which are automatically loaded from the EPROM to configure the MPC8272) and message and doorbell registers
  - Supports the I_2O standard
  - Hot-Swap friendly (supports the Hot Swap Specification as defined by PICMG 2.1 R1.0 August 3, 1998)
  - Support for 66 MHz, 3.3 V specification
  - 60x-PCI bus core logic, which uses a buffer pool to allocate buffers for each port

2 Operating Conditions

This table shows the maximum electrical ratings.

Table 3. Absolute Maximum Ratings[1]

Rating	Symbol	Value	Unit
Core supply voltage[2]	VDD	–0.3 – 2.25	V
PLL supply voltage[2]	VCCSYN	–0.3 – 2.25	V
I/O supply voltage[3]	VDDH	–0.3 – 4.0	V
Input voltage[4]	VIN	GND(–0.3) – 3.6	V
Junction temperature	T_j	120	°C
Storage temperature range	T_{STG}	(–55) – (+150)	°C

1 Absolute maximum ratings are stress ratings only; functional operation (see Table 4) at the maximums is not guaranteed. Stress beyond those listed may affect device reliability or cause permanent damage.

2 **Caution:** VDD/VCCSYN must not exceed VDDH by more than 0.4 V during normal operation. It is recommended that VDD/VCCSYN should be raised before or simultaneous with VDDH during power-on reset. VDD/VCCSYN may exceed VDDH by more than 0.4 V during power-on reset for no more than 100 ms.

3 **Caution:** VDDH can exceed VDD/VCCSYN by 3.3 V during power on reset by no more than 100 mSec. VDDH should not exceed VDD/VCCSYN by more than 2.5 V during normal operation.

4 **Caution:** VIN must not exceed VDDH by more than 2.5 V at any time, including during power-on reset.

3 DC Electrical Characteristics

This table shows DC electrical characteristics.

Table 5. DC Electrical Characteristics[1]

Characteristic	Symbol	Min	Max	Unit
Input high voltage—all inputs except TCK, $\overline{\text{TRST}}$ and $\overline{\text{PORESET}}$[2]	V_{IH}	2.0	3.465	V
Input low voltage[3]	V_{IL}	GND	0.8	V
CLKIN input high voltage	V_{IHC}	2.4	3.465	V
CLKIN input low voltage	V_{ILC}	GND	0.4	V
Input leakage current, V_{IN} = VDDH[4]	I_{IN}	—	10	μA
Hi-Z (off state) leakage current, V_{IN} = VDDH[2]	I_{OZ}	—	10	μA
Signal low input current, V_{IL} = 0.8 V	I_L	—	1	μA
Signal high input current, V_{IH} = 2.0 V	I_H	—	1	μA
Output high voltage, I_{OH} = –2 mA except UTOPIA mode, and open drain pins In UTOPIA mode[5] (UTOPIA pins only): I_{OH} = -8.0mA PA[8–31] PB[18–31] PC[0–1,4–29] PD[7–25, 29–31]	V_{OH}	2.4	—	V
In UTOPIA mode[5] (UTOPIA pins only): I_{OL} = 8.0mA PA[8–31] PB[18–31] PC[0–1,4–29] PD[7–25, 29–31]	V_{OL}	—	0.5	V

6 AC Electrical Characteristics

The following sections include illustrations and tables of clock diagrams, signals, and CPM outputs and inputs for 66.67/83.33/100/133 MHz devices. Note that AC timings are based on a 50-pf load for MAX Delay and 10-pf load for MIN delay. Typical output buffer impedances are shown in this table.

Table 9. Output Buffer Impedances[1]

Output Buffers	Typical Impedance (Ω)
60x bus	45 or 27[2]
Memory controller	45 or 27[2]
Parallel I/O	45
PCI	27

1 These are typical values at 65° C. Impedance may vary by ±25% with process and temperature.
2 Impedance value is selected through SIUMCR[20,21]. See the SoC reference manual.

6.1 CPM AC Characteristics

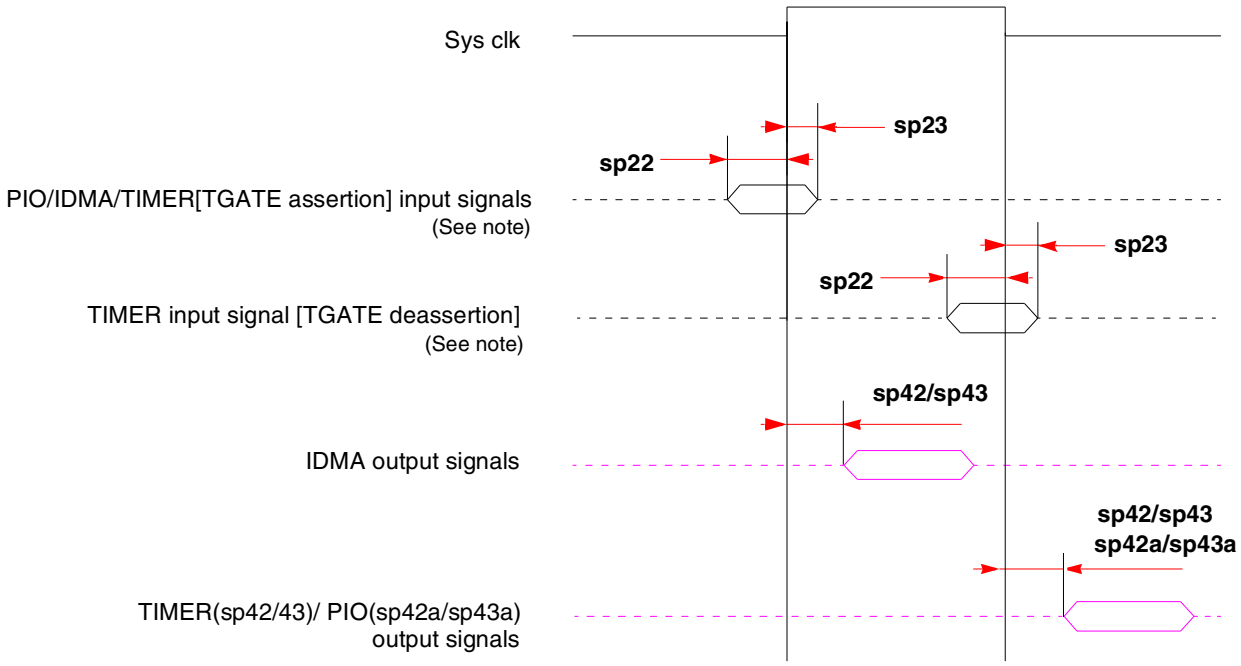
This table lists CPM output characteristics.

Table 10. AC Characteristics for CPM Outputs[1]

Spec Number		Characteristic	Value (ns)							
			Maximum Delay				Minimum Delay			
Max	Min		66 MHz	83 MHz	100 MHz	133 MHz	66 MHz	83 MHz	100 MHz	133 MHz
sp36a	sp37a	FCC outputs—internal clock (NMSI)	6	5.5	5.5	5.5	0.5	0.5	0.5	0.5
sp36b	sp37b	FCC outputs—external clock (NMSI)	8	8	8	8	2	2	2	2
sp38a	sp39a	SCC/SMC/SPI/I2C outputs—internal clock (NMSI)	10	10	10	10	0	0	0	0
sp38b	sp39b	SCC/SMC/SPI/I2C outputs—external clock (NMSI)	8	8	8	8	2	2	2	2
sp40	sp41	TDM outputs/SI	11	11	11	11	2.5	2.5	2.5	2.5
sp42	sp43	TIMER/IDMA outputs	11	11	11	11	0.5	0.5	0.5	0.5
sp42a	sp43a	PIO outputs	11	11	11	11	0.5	0.5	0.5	0.5

1 Output specifications are measured from the 50% level of the rising edge of CLKIN to the 50% level of the signal. Timings are measured at the pin.

This figure shows PIO and timer signals.



Note: TGATE is asserted on the rising edge of the clock; it is deasserted on the falling edge.

Figure 8. PIO and Timer Signal Diagram

6.2 SIU AC Characteristics

This table lists SIU input characteristics.

NOTE: CLKIN Jitter and Duty Cycle

The CLKIN input to the SoC should not exceed +/– 150 psec of jitter (peak-to-peak). This represents total input jitter—the combination of short term (peak-to-peak) and long term (cumulative). The duty cycle of CLKIN should not exceed the ratio of 40:60.

NOTE: Spread Spectrum Clocking

Spread spectrum clocking is allowed with 1% input frequency down-spread at maximum 60 KHz modulation rate regardless of input frequency.

NOTE: PCI AC Timing

The SoC meets the timing requirements of *PCI Specification Revision 2.2*. See Section 7, “Clock Configuration Modes,” and “Note: Tval (Output Hold)” to determine if a specific clock configuration is compliant.

This figure shows signal behavior in MEMC mode.

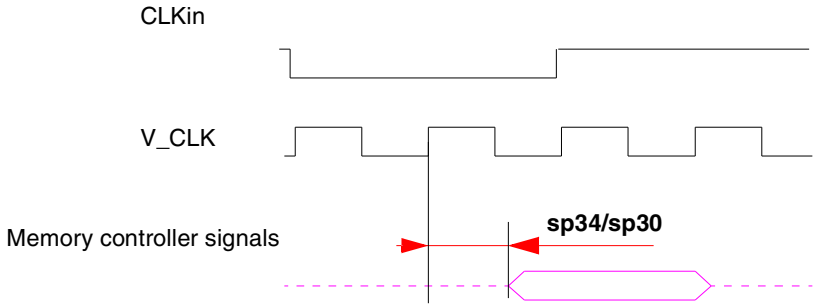


Figure 10. MEMC Mode Diagram

NOTE

Generally, all SoC bus and system output signals are driven from the rising edge of the input clock (CLKin). Memory controller signals, however, trigger on four points within a CLKin cycle. Each cycle is divided by four internal ticks: T1, T2, T3, and T4. T1 always occurs at the rising edge, and T3 at the falling edge, of CLKin. However, the spacing of T2 and T4 depends on the PLL clock ratio selected, as shown in Table 14.

Table 14. Tick Spacing for Memory Controller Signals

PLL Clock Ratio	Tick Spacing (T1 Occurs at the Rising Edge of CLKin)		
	T2	T3	T4
1:2, 1:3, 1:4, 1:5, 1:6	1/4 CLKin	1/2 CLKin	3/4 CLKin
1:2.5	3/10 CLKin	1/2 CLKin	8/10 CLKin
1:3.5	4/14 CLKin	1/2 CLKin	11/14 CLKin

This table is a representation of the information in Table 14.

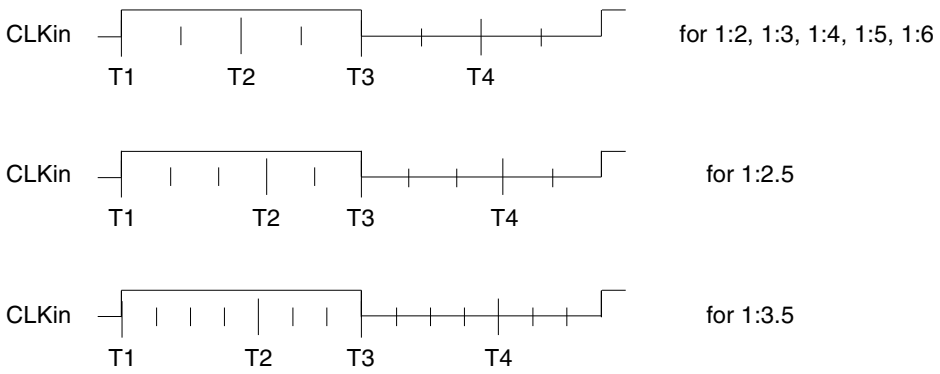


Figure 11. Internal Tick Spacing for Memory Controller Signals

Table 17. Clock Configurations for PCI Host Mode (PCI_MODCK=0)[1,2]

Mode[3]	Bus Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		PCI Division Factor[6]	PCI Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
Default Modes (MODCK_H=0000)											
0000_000	60.0	66.7	2	120.0	133.3	2.5	150.0	166.7	2	60.0	66.7
0000_001	50.0	66.7	2	100.0	133.3	3	150.0	200.0	2	50.0	66.7
0000_010	60.0	80.0	2.5	150.0	200.0	3	180.0	240.0	3	50.0	66.7
0000_011	60.0	80.0	2.5	150.0	200.0	3.5	210.0	280.0	3	50.0	66.7
0000_100	60.0	80.0	2.5	150.0	200.0	4	240.0	320.0	3	50.0	66.7
0000_101	50.0	66.7	3	150.0	200.0	3	150.0	200.0	3	50.0	66.7
0000_110	50.0	66.7	3.5	150.0	200.0	3.5	175.0	233.3	3	50.0	66.7
0000_111	50.0	66.7	3	150.0	200.0	4	200.0	266.6	3	50.0	66.7
Full Configuration Modes											
0001_000	50.0	66.7	3	150.0	200.0	5	250.0	333.3	3	50.0	66.7
0001_001	50.0	66.7	3	150.0	200.0	6	300.0	400.0	3	50.0	66.7
0001_010	50.0	66.7	3	150.0	200.0	7	350.0	466.6	3	50.0	66.7
0001_011	50.0	66.7	3	150.0	200.0	8	400.0	533.3	3	50.0	66.7
0010_000	50.0	66.7	4	200.0	266.6	5	250.0	333.3	4	50.0	66.7
0010_001	50.0	66.7	4	200.0	266.6	6	300.0	400.0	4	50.0	66.7
0010_010	50.0	66.7	4	200.0	266.6	7	350.0	466.6	4	50.0	66.7
0010_011	50.0	66.7	4	200.0	266.6	8	400.0	533.3	4	50.0	66.7
0010_100	75.0	100.0	4	300.0	400.0	5	375.0	500.0	6	50.0	66.7
0010_101	75.0	100.0	4	300.0	400.0	5.5	412.5	549.9	6	50.0	66.7
0010_110	75.0	100.0	4	300.0	400.0	6	450.0	599.9	6	50.0	66.7
0011_000	50.0	66.7	5	250.0	333.3	5	250.0	333.3	5	50.0	66.7
0011_001	50.0	66.7	5	250.0	333.3	6	300.0	400.0	5	50.0	66.7
0011_010	50.0	66.7	5	250.0	333.3	7	350.0	466.6	5	50.0	66.7
0011_011	50.0	66.7	5	250.0	333.3	8	400.0	533.3	5	50.0	66.7
0100_000	Reserved										

Table 17. Clock Configurations for PCI Host Mode (PCI_MODCK=0)[1,2] (continued)

Mode[3]	Bus Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		PCI Division Factor[6]	PCI Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
1011_100	80.0	106.7	2.5	200.0	266.6	4	320.0	426.6	4	50.0	66.7
1011_101	80.0	106.7	2.5	200.0	266.6	4.5	360.0	480.0	4	50.0	66.7
1101_000	100.0	133.3	2.5	250.0	333.3	3	300.0	400.0	5	50.0	66.7
1101_001	100.0	133.3	2.5	250.0	333.3	3.5	350.0	466.6	5	50.0	66.7
1101_010	100.0	133.3	2.5	250.0	333.3	4	400.0	533.3	5	50.0	66.7
1101_011	100.0	133.3	2.5	250.0	333.3	4.5	450.0	599.9	5	50.0	66.7
1101_100	100.0	133.3	2.5	250.0	333.3	5	500.0	666.6	5	50.0	66.7
1101_101	125.0	166.7	2	250.0	333.3	3	375.0	500.0	5	50.0	66.7
1101_110	125.0	166.7	2	250.0	333.3	4	500.0	666.6	5	50.0	66.7
1110_000	100.0	133.3	3	300.0	400.0	3.5	350.0	466.6	6	50.0	66.7
1110_001	100.0	133.3	3	300.0	400.0	4	400.0	533.3	6	50.0	66.7
1110_010	100.0	133.3	3	300.0	400.0	4.5	450.0	599.9	6	50.0	66.7
1110_011	100.0	133.3	3	300.0	400.0	5	500.0	666.6	6	50.0	66.7
1110_100	100.0	133.3	3	300.0	400.0	5.5	550.0	733.3	6	50.0	66.7
1100_000	Reserved										
1100_001	Reserved										
1100_010	Reserved										

1 The “low” values are the minimum allowable frequencies for a given clock mode. The minimum bus frequency in a table entry guarantees only the required minimum CPU operating frequency. The “high” values are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user’s device. The minimum CPU frequency is 150 MHz for commercial temperature devices and 175 MHz for extended temperature devices. The minimum CPM frequency is 120 MHz.

2 PCI_MODCK determines the PCI clock frequency range. SeeTable 18 for lower range configurations.

3 MODCK_H = hard reset configuration word [28–31] (see Section 5.4 in the SoC reference manual). MODCK[1-3] = three hardware configuration pins.

4 CPM multiplication factor = CPM clock/bus clock

5 CPU multiplication factor = Core PLL multiplication factor

6 CPM_CLK/PCI_CLK ratio. When PCI_MODCK = 0, the ratio of CPM_CLK/PCI_CLK should be calculated from SCCR[PCIDF] as follows:
CPM_CLK/PCI_CLK = (PCIDF + 1) / 2.

Table 18. Clock Configurations for PCI Host Mode (PCI_MODCK=1)[1,2] (continued)

Mode[3]	Bus Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		PCI Division Factor[6]	PCI Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
1000_010	66.7	133.3	3	200.0	400.0	3.5	233.3	466.7	8	25.0	50.0
1000_011	66.7	133.3	3	200.0	400.0	4	266.7	533.3	8	25.0	50.0
1000_100	66.7	133.3	3	200.0	400.0	4.5	300.0	600.0	8	25.0	50.0
1000_101	66.7	133.3	3	200.0	400.0	6	400.0	800.0	8	25.0	50.0
1000_110	66.7	133.3	3	200.0	400.0	6.5	433.3	866.7	8	25.0	50.0
1001_000	Reserved										
1001_001	Reserved										
1001_010	57.1	114.3	3.5	200.0	400.0	3.5	200.0	400.0	8	25.0	50.0
1001_011	57.1	114.3	3.5	200.0	400.0	4	228.6	457.1	8	25.0	50.0
1001_100	57.1	114.3	3.5	200.0	400.0	4.5	257.1	514.3	8	25.0	50.0
1001_101	42.9	85.7	3.5	150.0	300.0	5	214.3	428.6	6	25.0	50.0
1001_110	42.9	85.7	3.5	150.0	300.0	5.5	235.7	471.4	6	25.0	50.0
1001_111	42.9	85.7	3.5	150.0	300.0	6	257.1	514.3	6	25.0	50.0
1010_000	75.0	150.0	2	150.0	300.0	2	150.0	300.0	6	25.0	50.0
1010_001	75.0	150.0	2	150.0	300.0	2.5	187.5	375.0	6	25.0	50.0
1010_010	75.0	150.0	2	150.0	300.0	3	225.0	450.0	6	25.0	50.0
1010_011	75.0	150.0	2	150.0	300.0	3.5	262.5	525.0	6	25.0	50.0
1010_100	75.0	150.0	2	150.0	300.0	4	300.0	600.0	6	25.0	50.0
1010_101	100.0	200.0	2	200.0	400.0	2.5	250.0	500.0	8	25.0	50.0
1010_110	100.0	200.0	2	200.0	400.0	3	300.0	600.0	8	25.0	50.0
1010_111	100.0	200.0	2	200.0	400.0	3.5	350.0	700.0	8	25.0	50.0
1011_000	Reserved										
1011_001	80.0	160.0	2.5	200.0	400.0	2.5	200.0	400.0	8	25.0	50.0
1011_010	80.0	160.0	2.5	200.0	400.0	3	240.0	480.0	8	25.0	50.0
1011_011	80.0	160.0	2.5	200.0	400.0	3.5	280.0	560.0	8	25.0	50.0
1011_100	80.0	160.0	2.5	200.0	400.0	4	320.0	640.0	8	25.0	50.0

6 CPM_CLK/PCI_CLK ratio. When PCI_MODCK = 1, the ratio of CPM_CLK/PCI_CLK should be calculated from PCIDF as follows:
PCIDF = 3 > CPM_CLK/PCI_CLK = 4
PCIDF = 5 > CPM_CLK/PCI_CLK = 6
PCIDF = 7 > CPM_CLK/PCI_CLK = 8
PCIDF = 9 > CPM_CLK/PCI_CLK = 5
PCIDF = B > CPM_CLK/PCI_CLK = 6

7.2 PCI Agent Mode

These tables show configurations for PCI agent mode. The frequency values listed are for the purpose of illustration only. Users must select a mode and input bus frequency so that the resulting configuration does not exceed the frequency rating of the user's device. Note that in PCI agent mode the input clock is PCI clock.

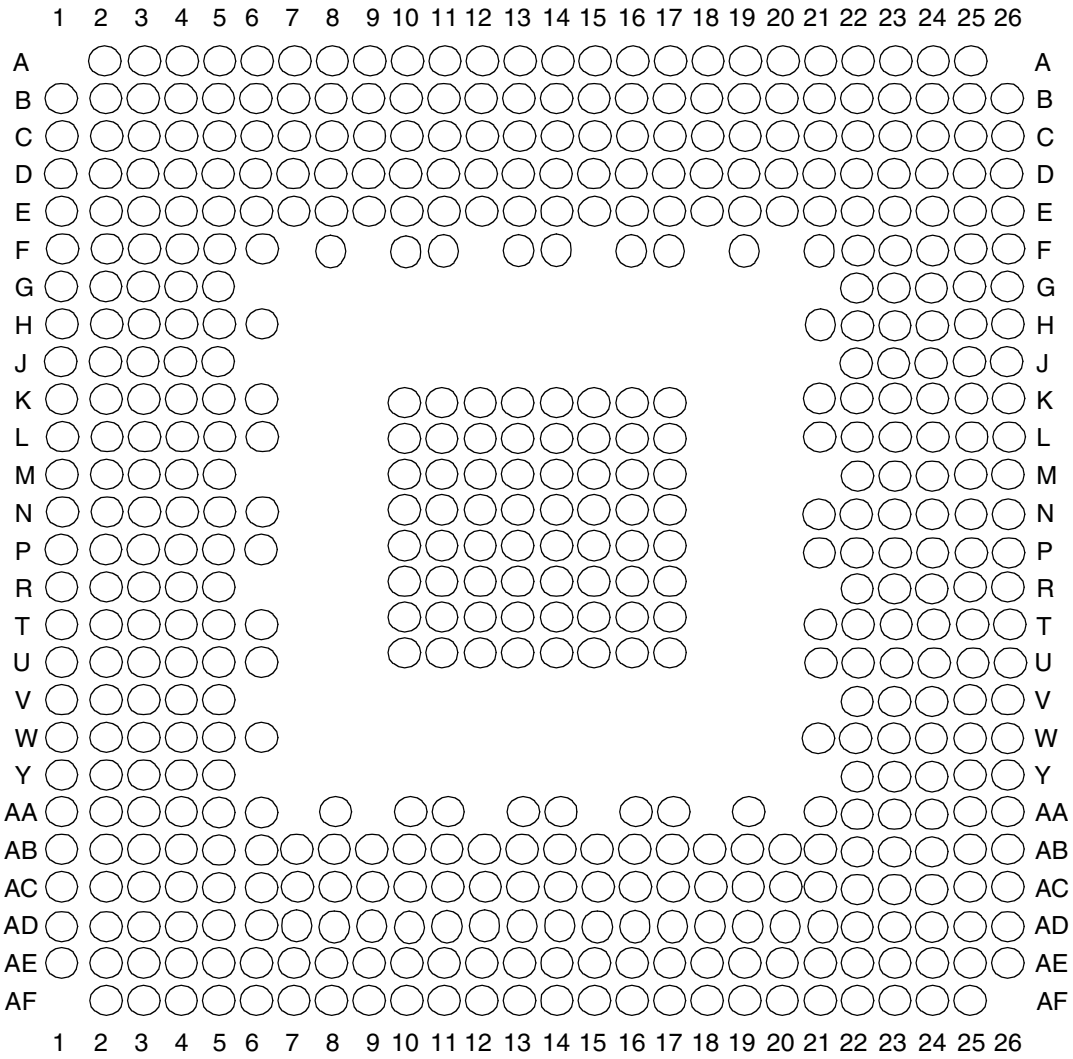
Table 19. Clock Configurations for PCI Agent Mode (PCI_MODCK=0)[1,2]

Mode[3]	PCI Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
Default Modes (MODCK_H=0000)											
0000_000	60.0	66.7	2	120.0	133.3	2.5	150.0	166.7	2	60.0	66.7
0000_001	50.0	66.7	2	100.0	133.3	3	150.0	200.0	2	50.0	66.7
0000_010	50.0	66.7	3	150.0	200.0	3	150.0	200.0	3	50.0	66.7
0000_011	50.0	66.7	3	150.0	200.0	4	200.0	266.6	3	50.0	66.7
0000_100	50.0	66.7	3	150.0	200.0	3	180.0	240.0	2.5	60.0	80.0
0000_101	50.0	66.7	3	150.0	200.0	3.5	210.0	280.0	2.5	60.0	80.0
0000_110	50.0	66.7	4	200.0	266.6	3.5	233.3	311.1	3	66.7	88.9
0000_111	50.0	66.7	4	200.0	266.6	3	240.0	320.0	2.5	80.0	106.7
Full Configuration Modes											
0001_001	60.0	66.7	2	120.0	133.3	5	150.0	166.7	4	30.0	33.3
0001_010	50.0	66.7	2	100.0	133.3	6	150.0	200.0	4	25.0	33.3
0001_011	50.0	66.7	2	100.0	133.3	7	175.0	233.3	4	25.0	33.3
0001_100	50.0	66.7	2	100.0	133.3	8	200.0	266.6	4	25.0	33.3
0010_001	50.0	66.7	3	150.0	200.0	3	180.0	240.0	2.5	60.0	80.0
0010_010	50.0	66.7	3	150.0	200.0	3.5	210.0	280.0	2.5	60.0	80.0
0010_011	50.0	66.7	3	150.0	200.0	4	240.0	320.0	2.5	60.0	80.0
0010_100	50.0	66.7	3	150.0	200.0	4.5	270.0	360.0	2.5	60.0	80.0

Table 20. Clock Configurations for PCI Agent Mode (PCI_MODCK=1)[1,2] (continued)

Mode[3]	PCI Clock (MHz)		CPM Multiplication Factor[4]	CPM Clock (MHz)		CPU Multiplication Factor[5]	CPU Clock (MHz)		Bus Division Factor	Bus Clock (MHz)	
MODCK_H-MODCK[1-3]	Low	High		Low	High		Low	High		Low	High
1001_010	Reserved										
1001_011	25.0	50.0	8	200.0	400.0	4	200.0	400.0	4	50.0	100.0
1001_100	25.0	50.0	8	200.0	400.0	4.5	225.0	450.0	4	50.0	100.0
1010_000	Reserved										
1010_001	25.0	50.0	8	200.0	400.0	3	200.0	400.0	3	66.7	133.3
1010_010	25.0	50.0	8	200.0	400.0	3.5	233.3	466.7	3	66.7	133.3
1010_011	25.0	50.0	8	200.0	400.0	4	266.7	533.3	3	66.7	133.3
1010_100	25.0	50.0	8	200.0	400.0	4.5	300.0	600.0	3	66.7	133.3
1011_000	Reserved										
1011_001	25.0	50.0	8	200.0	400.0	2.5	200.0	400.0	2.5	80.0	160.0
1011_010	25.0	50.0	8	200.0	400.0	3	240.0	480.0	2.5	80.0	160.0
1011_011	25.0	50.0	8	200.0	400.0	3.5	280.0	560.0	2.5	80.0	160.0
1011_100	25.0	50.0	8	200.0	400.0	4	320.0	640.0	2.5	80.0	160.0
1011_101	25.0	50.0	8	200.0	400.0	2.5	250.0	500.0	2	100.0	200.0
1011_110	25.0	50.0	8	200.0	400.0	3	300.0	600.0	2	100.0	200.0
1011_111	25.0	50.0	8	200.0	400.0	3.5	350.0	700.0	2	100.0	200.0
1100_101	25.0	50.0	6	150.0	300.0	4	200.0	400.0	3	50.0	100.0
1100_110	25.0	50.0	6	150.0	300.0	4.5	225.0	450.0	3	50.0	100.0
1100_111	25.0	50.0	6	150.0	300.0	5	250.0	500.0	3	50.0	100.0
1101_000	25.0	50.0	6	150.0	300.0	5.5	275.0	550.0	3	50.0	100.0
1101_001	25.0	50.0	6	150.0	300.0	3.5	210.0	420.0	2.5	60.0	120.0
1101_010	25.0	50.0	6	150.0	300.0	4	240.0	480.0	2.5	60.0	120.0
1101_011	25.0	50.0	6	150.0	300.0	4.5	270.0	540.0	2.5	60.0	120.0
1101_100	25.0	50.0	6	150.0	300.0	5	300.0	600.0	2.5	60.0	120.0

This figure shows the pinout of the 516 PBGA package as viewed from the top surface.



Not to Scale

Figure 12. Pinout of the 516 PBGA Package (View from Top)

This table lists the pins of the MPC8272. Note that the pins in the “MPC8272/8271 Only” column relate to Utopia functionality.

Table 21. Pinout

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
$\overline{BR}$		A19
$\overline{BG}$/$\overline{IRQ6}$		D2
$\overline{ABB}$/$\overline{IRQ2}$		C1

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
A30		B15
A31		A15
TT0		B3
TT1		E8
TT2		D7
TT3		C4
TT4		E7
$\overline{\text{TBST}}$		E3
TSIZ0		E4
TSIZ1		E5
TSIZ2		C3
TSIZ3		D5
$\overline{\text{AACK}}$		D3
$\overline{\text{ARTRY}}$		C2
$\overline{\text{DBG}}$/$\overline{\text{IRQ7}}$		F16
$\overline{\text{DBB}}$/$\overline{\text{IRQ3}}$		D18
D0		AC1
D1		AA1
D2		V3
D3		R5
D4		P4
D5		M4
D6		J4
D7		G1
D8		W6
D9		Y3
D10		V1
D11		N6
D12		P3
D13		M2
D14		J5

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
D15		G3
D16		AB3
D17		Y1
D18		T4
D19		T3
D20		P2
D21		M1
D22		J1
D23		G4
D24		AB2
D25		W4
D26		V2
D27		T1
D28		N5
D29		L1
D30		H1
D31		G5
D32		W5
D33		W2
D34		T5
D35		T2
D36		N1
D37		K3
D38		H2
D39		F1
D40		AA2
D41		W1
D42		U3
D43		R2
D44		N2
D45		L2

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
$\overline{\text{CS2}}$		AF5
$\overline{\text{CS3}}$		AC8
$\overline{\text{CS4}}$		AF6
$\overline{\text{CS5}}$		AD8
$\overline{\text{CS6}}$/BCTL1/$\overline{\text{SMI}}$		AC9
$\overline{\text{CS7}}$/TLBISYNC		AB9
BADDR27/$\overline{\text{IRQ1}}$		AB8
BADDR28/$\overline{\text{IRQ2}}$		AC7
ALE/$\overline{\text{IRQ4}}$		AF4
$\overline{\text{BCTL0}}$		AF3
$\overline{\text{PWE0}}$/$\overline{\text{PSDDQM0}}$/$\overline{\text{PBS0}}$		AD6
$\overline{\text{PWE1}}$/$\overline{\text{PSDDQM1}}$/$\overline{\text{PBS1}}$		AE5
$\overline{\text{PWE2}}$/$\overline{\text{PSDDQM2}}$/$\overline{\text{PBS2}}$		AE3
$\overline{\text{PWE3}}$/$\overline{\text{PSDDQM3}}$/$\overline{\text{PBS3}}$		AF2
$\overline{\text{PWE4}}$/$\overline{\text{PSDDQM4}}$/$\overline{\text{PBS4}}$		AC6
$\overline{\text{PWE5}}$/$\overline{\text{PSDDQM5}}$/$\overline{\text{PBS5}}$		AC5
$\overline{\text{PWE6}}$/$\overline{\text{PSDDQM6}}$/$\overline{\text{PBS6}}$		AD4
$\overline{\text{PWE7}}$/$\overline{\text{PSDDQM7}}$/$\overline{\text{PBS7}}$		AB5
PSDA10/PGPL0		AE2
$\overline{\text{PSDWE}}$/PGPL1		AD3
$\overline{\text{POE}}$/$\overline{\text{PSDRAS}}$/PGPL2		AB4
$\overline{\text{PSDCAS}}$/PGPL3		AC3
$\overline{\text{PGTA}}$/PUPMWAIT/PGPL4		AD2
PSDAMUX/PGPL5		AC2
$\overline{\text{PCI\_MODE}}$[1]		AD22
PCI_CFG0 ($\overline{\text{PCI\_HOST\_EN}}$)		AC21
PCI_CFG1 ($\overline{\text{PCI\_ARB\_EN}}$)		AE22
PCI_CFG2 (DLL_ENABLE)		AE23
PCI_ PAR		AF12
$\overline{\text{PCI\_FRAME}}$		AD15
$\overline{\text{PCI\_TRDY}}$		AF16

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
PCI_AD16		AE16
PCI_AD17		AF17
PCI_AD18		AD16
PCI_AD19		AC16
PCI_AD20		AF18
PCI_AD21		AB16
PCI_AD22		AD17
PCI_AD23		AF19
PCI_AD24		AB17
PCI_AD25		AF20
PCI_AD26		AE19
PCI_AD27		AC18
PCI_AD28		AB18
PCI_AD29		AD19
PCI_AD30		AD21
PCI_AD31		AC20
$\overline{\text{PCI\_C0}}/\overline{\text{BE0}}$		AE12
$\overline{\text{PCI\_C1}}/\overline{\text{BE1}}$		AF13
$\overline{\text{PCI\_C2}}/\overline{\text{BE2}}$		AC15
$\overline{\text{PCI\_C3}}/\overline{\text{BE3}}$		AE18
$\overline{\text{IRQ0}}/\overline{\text{NMI\_OUT}}$		A17
$\overline{\text{TRST}}$[2]		E21
TCK		B22
TMS		C23
TDI		B24
TDO		A22
$\overline{\text{TRIS}}$		B23
$\overline{\text{PORESET}}$[2]/$\overline{\text{PCI\_RST}}$		C24
$\overline{\text{HRESET}}$		D22
$\overline{\text{SRESET}}$		F22
$\overline{\text{RSTCONF}}$		A24

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	**MPC8272/MPC8271 Only**	
PA31/FCC1_MII_COL	$\overline{\text{FCC1\_UT\_TXENB}}$	G22[3]
PB18/FCC2_MII_HDLC_RXD3		T25[3]
PB19/FCC2_MII_HDLC_RXD2		P22[3]
PB20/FCC2_MII_HDLC_RMII_RXD1		L25[3]
PB21/FCC2_MII_HDLC_RMII_RXD0/FCC2_TRAN_RXD		J26[3]
PB22/FCC2_MII_HDLC_TXD0/FCC2_TRAN_TXD/ FCC2_RMII_TXD0		U23[3]
PB23/FCC2_MII_HDLC_TXD1/FCC2_RMII_TXD1		U26[3]
PB24/FCC2_MII_HDLC_TXD2/L1RSYNCB2		M24[3]
PB25/FCC2_MII_HDLC_TXD3/L1TSYNCB2		M23[3]
PB26/FCC2_MII_CRS/L1RXDB2		H24[3]
PB27/FCC2_MII_COL/L1TXDB2		E25[3]
PB28/FCC2_MII_RMII_RX_ER/$\overline{\text{FCC2\_RTS}}$/TXD1		D26[3]
PB29/FCC2_MII_RMII_TX_EN		K21[3]
PB30/FCC2_MII_RX_DV/FCC2_RMII_CRS_DV		D24[3]
PB31/FCC2_MII_TX_ER		E23[3]
PC0/$\overline{\text{DREQ3}}$/BRGO7/$\overline{\text{SMSYN1}}$/L1CLKOA2		AF23[3]
PC1/BRGO6/$\overline{\text{L1RQA2}}$		AD23[3]
PC4/SMRXD1/SI2_L1ST4/$\overline{\text{FCC2\_CD}}$		AB22[3]
PC5/SMTXD1/SI2_L1ST3/$\overline{\text{FCC2\_CTS}}$		AE24[3]
PC6/$\overline{\text{FCC1\_CD}}$/SI2_L1ST2	FCC1_UT_RXADDR2	AF24[3]
PC7/$\overline{\text{FCC1\_CTS}}$	FCC1_UT_TXADDR2	AE26[3]
PC8/$\overline{\text{CD4}}$/RTS1/SI2_L1ST2/$\overline{\text{CTS3}}$		AC24[3]
PC9/$\overline{\text{CTS4}}$/L1TSYNCA2		AA23[3]
PC10/$\overline{\text{CD3}}$/USB_RN		AB25[3]
PC11/$\overline{\text{CTS3}}$/USB_RP/L1TXD3A2		V22[3]
PC12	FCC1_UT_RXADDR1	AA26[3]
PC13/BRGO5	FCC1_UT_TXADDR1	V23[3]
PC14/$\overline{\text{CD1}}$	FCC1_UT_RXADDR0	W24[3]
PC15/$\overline{\text{CTS1}}$	FCC1_UT_TXADDR0	U24[3]
PC16/CLK16		T23[3]

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
PC17/CLK15/BRGO8/$\overline{\text{DONE2}}$		T26[3]
PC18/CLK14/$\overline{\text{TGATE2}}$		R26[3]
PC19/CLK13/BRGO7/$\overline{\text{TGATE1}}$		P24[3]
PC20/CLK12/$\overline{\text{USBOE}}$		L26[3]
PC21/CLK11/BRGO6/CP_INT		L24[3]
PC22/CLK10/$\overline{\text{DONE3}}$	FCC1_UT_TXPRTY	L23[3]
PC23/CLK9/BRGO5/$\overline{\text{DACK3}}$/$\overline{\text{CD1}}$		K24[3]
PC24/CLK8/TIN3/$\overline{\text{TOUT4}}$/DREQ2/BRGO1		K23[3]
PC25/CLK7/BRGO4/$\overline{\text{DACK2}}$/SPISEL		F26[3]
PC26/CLK6/$\overline{\text{TOUT3}}$/TMCLK		H23[3]
PC27/CLK5/BRGO3/$\overline{\text{TOUT1}}$	FCC1_UT_RXPRTY	K22[3]
PC28/CLK4/TIN1/$\overline{\text{TOUT2}}$/SPICLK		D25[3]
PC29/CLK3/TIN2/BRGO2/$\overline{\text{CTS1}}$		F24[3]
PD7/SMSYN2	FCC1_UT_TXADDR3	AB21[3]
PD14/I2CSCL		AC26[3]
PD15/I2CSDA		Y23[3]
PD16/SPIMISO	FCC1_UT_TXPRTY	AA25[3]
PD17/BRGO2/SPIMOSI	FCC1_UT_RXPRTY	Y26[3]
PD18/SPICLK	FCC1_UT_RXADDR4	W25[3]
PD19/SPISEL/BRGO1	FCC1_UT_TXADDR4	V25[3]
PD20/$\overline{\text{RTS4}}$/L1RSYNCA2		R24[3]
PD21/TXD4/L1RXD0A2		P23[3]
PD22/RXD4/L1TXD0A2		N25[3]
PD23/$\overline{\text{RTS3}}$/USB_TP		K26[3]
PD24/TXD3/USB_TN		K25[3]
PD25/RXD3/USB_RXD		J25[3]
PD29/$\overline{\text{RTS1}}$	FCC1_UT_RXADDR3	C26[3]
PD30/TXD1		E24[3]
PD31/RXD1		B25[3]
VCCSYN		C18
VCCSYN1		K6

Table 21. Pinout (continued)

Pin Name		Ball
MPC8272/MPC8248 and MPC8271/MPC8247	MPC8272/MPC8271 Only	
CLKIN2		C21
No connect[4]		D19[4], J3[4], AD24[5]
I/O power		B4, F3, J2, N4, AD1, AD5, AE8, AC13, AD18, AB24, AB26, W23, R25, M25, F25, C25, C22, B17, B12, B8, E6, F6, H6, L5, L6, P6, T6, U6, V5, Y5, AA6, AA8, AA10, AA11, AA14, AA16, AA17, AB19, AB20, W21, U21, T21, P21, N21, M22, J22, H21, F21, F19, F17, E16, F14, E13, E12, F10, E10, E9
Core Power		F5, K5, M5, AA5, AB7, AA13, AA19, AA21, Y22, AC25, U22, R22, L21, H22, E22, E20, E15, F13, F11, F8, L3, V4, W3, AC11, AD11, AB15, U25, T24, J24, H25, F23, B19, D17, C17, D10, C10
Ground		E19, E2, K1, Y2, AE1, AE4, AD9, AC14, AE17, AC19, AE25, V24, P26, M26, G26, E26, B21, C12, C11, C8, A8, B18, A18, A2, B1, B2, A5, C5, D4, D6, G2, L4, P1, R1, R4, AC4, AE7, AC23, Y25, N24, J23, A23, D23, D20, E18, A13, A16, K10, K11, K12, K13, K14, K15, K16, K17, L10, L11, L12, L13, L14, L15, L16, L17, M10, M11, M12, M13, M14, M15, M16, M17, N10, N11, N12, N13, N14, N15, N16, N17, P10, P11, P12, P13, P14, P15, P16, P17, R10, R11,R12, R13, R14, R15, R16, R17, T10, T11, T12, T13, T14, T15, T16, T17, U10, U11, U12, U13, U14, U15, U16, U17

1 Must be tied to ground.

2 Should be tied to VDDH via a 2K Ω external pull-up resistor.

3 The default configuration of the CPM pins (PA[8–31], PB[18–31], PC[0–1,4–29], PD[7–25, 29–31]) is input. To prevent excessive DC current, it is recommended either to pull unused pins to GND or VDDH, or to configure them as outputs.

4 This pin is not connected. It should be left floating.

5 Must be pulled down or left floating